

# ±14,000°/sec Digital Gyroscope Sensor

Data Sheet ADIS16266

#### **FEATURES**

Yaw rate gyroscope with range scaling ±3500°/sec, ±7000°/sec, and ±14,000°/sec settings

2429 SPS sample rate

Wide sensor bandwidth: 360 Hz

No external configuration required to start data collection

Start-up time: 170 ms

Sleep mode recovery time: 2.5 ms Factory-calibrated sensitivity and bias

Calibration temperature range: -40°C to +70°C

**SPI-compatible serial interface** 

Relative angle displacement output

**Embedded temperature sensor** 

**Programmable operation and control** 

Automatic and manual bias correction controls

Bartlett window FIR filter length, number of taps

Digital I/O: data ready, alarm indicator, general-purpose

Alarms for condition monitoring

Sleep mode for power management

**DAC** output voltage

Single-command self-test

Single-supply operation: 4.75 V to 5.25 V

3.3 V compatible digital lines 2000 *q* shock survivability

Operating temperature range: -40°C to +105°C

#### **APPLICATIONS**

Platform control and stabilization Navigation Medical instrumentation Robotics

#### **GENERAL DESCRIPTION**

The ADIS16266 is a programmable digital gyroscope that combines industry-leading MEMS and signal processing technology in a single compact package. It provides accuracy performance that would otherwise require full motion calibration with any other MEMS gyroscope in this performance class. When power is applied, the ADIS16266 automatically starts up and begins sampling sensor data, without requiring configuration commands from a system processor. An addressable register structure and a common serial peripheral interface (SPI) provide simple access to sensor data and configuration settings. Many digital processor platforms support the SPI with simple firmware level instructions.

The ADIS16266 provides several programmable features for in-system optimization. The Bartlett window FIR filter length and sample rate settings provide users with controls that enable noise vs. bandwidth optimization. The digital input/output lines offer options for a data ready signal that helps the master processor efficiently manage data coherency, an alarm indicator signal for triggering master processor interrupts, and a general-purpose function for setting and monitoring system level digital controls/conditions.

The ADIS16266 is pin-compatible with the ADIS1625x and ADIS1626x families and comes in an LGA package (11.2 mm  $\times$  11.2 mm  $\times$  5.5 mm) that meets Pb-free solder reflow profile requirements, per JEDEC J-STD-020. It offers an extended operating temperature range of  $-40^{\circ}$ C to  $+105^{\circ}$ C.

#### **FUNCTIONAL BLOCK DIAGRAM**

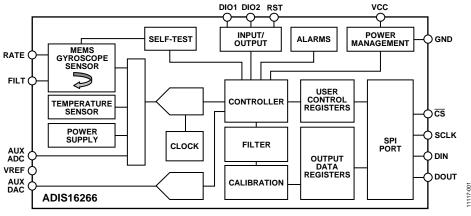


Figure 1.

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# **SPECIFICATIONS**

 $T_A = -40$ °C to +105°C, VCC = 5.0 V, angular rate = 0°/sec,  $\pm 1$  g,  $\pm 14,000$ °/sec range setting, unless otherwise noted.

Table 1.

Parameter	Test Conditions/Comments	Min	Тур	Max	Unit
SENSITIVITY <sup>1</sup>	Clockwise rotation is positive output				
	25°C, dynamic range = $\pm 14,000^{\circ}/\text{sec}^2$		4.17		°/sec/LSB
	25°C, dynamic range = ±7000°/sec		2.08		°/sec/LSB
	25°C, dynamic range = ±3500°/sec		1.04		°/sec/LSB
Initial Tolerance	25°C, dynamic range = $\pm 14000$ °/sec, VDD = 5 V		±0.5	±2	%
Temperature Coefficient	4.75 V < VDD < 5.25 V		200		ppm/°C
Nonlinearity	Best fit straight line		0.1		% of FS
BIAS	-				
Initial Error			±15		°/sec
In-Run Bias Stability	25℃, 1 σ		470		°/hour
Angular Random Walk	25°C, 1 σ		21.5		°/√hour
Linear Acceleration Effect	25°C, 1 σ		0.1		°/sec/g
Temperature Coefficient			0.35		°/sec/°C
Voltage Sensitivity	$VCC = 4.75 \text{ V to } 5.25 \text{ V}, \mu \pm 1  \sigma$		7.5		°/sec/V
NOISE PERFORMANCE					
Output Noise	25°C, ±14,000°/sec range, no filtering		11.2		°/sec rms
	25°C, ±7000°/sec range, 4-tap filter setting		7.2		°/sec rms
	25°C, ±3500°/sec range, 16-tap filter setting		3.4		°/sec rms
Rate Noise Density	25°C, $f = 25$ Hz, $\pm 14,000$ °/sec range, no filtering		0.44		°/sec/√Hz rms
FREQUENCY RESPONSE					
3 dB Bandwidth			360		Hz
Sensor Resonant Frequency		16	18	20	kHz
SELF-TEST STATE					
Change for Positive Stimulus	±14,000°/sec dynamic range setting	150		500	LSB
Change for Negative Stimulus	±14,000°/sec dynamic range setting	-500		-150	LSB
Internal Self-Test Cycle Time	,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,		30		ms
ADC INPUT					
Resolution			12		Bits
Integral Nonlinearity			±2		LSB
Differential Nonlinearity			±1		LSB
Offset Error			±4		LSB
Gain Error			±2		LSB
Input Range		0		2.5	V
Input Capacitance	During acquisition		20		pF
ON-CHIP VOLTAGE REFERENCE			2.5		V
Accuracy	25°C	-10		+10	mV
Temperature Coefficient			±40		ppm/°C
Output Impedance			70		Ω
DAC OUTPUT	5 kΩ/100 pF to GND				1
Resolution	5 .22, 100 pt. to 5115		12		Bits
Relative Accuracy	For Code 101 to Code 4095		4		LSB
Differential Nonlinearity	. 5. 2342 101 10 2042 1073		1		LSB
Offset Error			±5		mV
Gain Error			±0.5		<b>%</b>
Output Range		0	≟0.5	2.5	V
Output Impedance		Ĭ	2	2.5	Ω
Output Impedance Output Settling Time			10		μs
output setting fille			10		μο

Parameter	Test Conditions/Comments	Min	Тур	Max	Unit
LOGIC INPUTS	Internal 3.3 V interface				
Input High Voltage, V <sub>INH</sub>	t High Voltage, V <sub>INH</sub>				V
Input Low Voltage, V <sub>INL</sub>				0.8	V
Logic 1 Input Current, I <sub>INH</sub>	$V_{IH} = 3.3 V$		±0.2	±10	μΑ
Logic 0 Input Current, IINL	$V_{IL} = 0 V$				
All Except RST			-40	-60	μΑ
RST	The RST pin has an internal pull-up.		-1		mA
Input Capacitance, C <sub>IN</sub>			10		pF
DIGITAL OUTPUTS	Internal 3.3 V interface				
Output High Voltage, V <sub>OH</sub>	I <sub>SOURCE</sub> = 1.6 mA	2.4			V
Output Low Voltage, V <sub>OL</sub>	$I_{SINK} = 1.6 \text{ mA}$			0.4	V
SLEEP TIMER					
Timeout Period <sup>3</sup>		0.5		128	sec
START-UP TIME					
Initial Start-Up Time			170		ms
Sleep Mode Recovery			2.5		ms
Reset Recovery			78		ms
Flash Memory Update Time			40		ms
Flash Memory Test Time			18		ms
Self-Test Time			30		ms
FLASH MEMORY					
Endurance <sup>4</sup>		20,000			Cycles
Data Retention <sup>5</sup>	T <sub>J</sub> = 55°C	10			Years
CONVERSION RATE					
Sample Rate			2429		SPS
Sample Rate Tolerance				±3	%
POWER SUPPLY					
Operating Voltage Range, Vcc		4.75	5.0	5.25	V
Power Supply Current			41		mA
	Sleep mode		400		μΑ

¹ Characterization data represents ±4σ to fall within the ±1% limit.
 ² The maximum guaranteed measurement range is ±14,000°/sec. The sensor outputs measure beyond this range, but performance is guaranteed.
 ³ Guaranteed by design.
 ⁴ Endurance is qualified as per JEDEC Standard 22, Method A117, and measured at -40°C, +25°C, +85°C, and +125°C.
 ⁵ Retention lifetime equivalent at a junction temperature (T<sub>j</sub>) of 55°C, as per JEDEC Standard 22, Method A117. Retention lifetime decreases with junction temperature.

#### **TIMING SPECIFICATIONS**

 $T_A = -40$ °C to +85°C, VCC = 5.0 V, unless otherwise noted.

Table 2.

Parameter	Description	Min <sup>1</sup>	Тур	Max <sup>1</sup>	Unit
f <sub>SCLK</sub>	Serial clock (not shown in figures)	0.01		2.5	MHz
t <sub>DATARATE</sub>	Data rate period	32			μs
<b>t</b> <sub>STALL</sub>	Stall period between data	9			μs
t <sub>⊂S</sub>	Chip select to clock edge	48.8			ns
t <sub>DAV</sub>	Data output valid after SCLK falling edge <sup>2</sup>	K falling edge <sup>2</sup>		100	ns
t <sub>DSU</sub>	Data input setup time before SCLK rising edge	24.4			ns
t <sub>DHD</sub>	Data input hold time after SCLK rising edge	48.8			ns
t <sub>DF</sub>	Data output fall time (not shown in figures)		5	12.5	ns
t <sub>DR</sub>	Data output rise time (not shown in figures)		5	12.5	ns
tsfs	CS high after SCLK edge <sup>3</sup>	5			ns

<sup>&</sup>lt;sup>1</sup> Guaranteed by design; not production tested.

#### **Timing Diagrams**

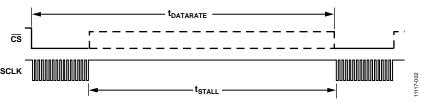


Figure 2. SPI Chip Select Timing

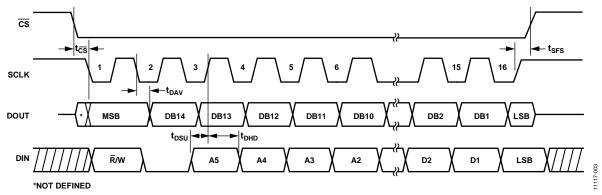


Figure 3. SPI Timing (Using SPI Settings Typically Identified as CPOL = 1, CPHA = 1)

<sup>&</sup>lt;sup>2</sup> The MSB presents an exception to this parameter. The MSB clocks out on the falling edge of CS. The remaining DOUT bits are clocked after the falling edge of SCLK and are governed by this specification.

<sup>&</sup>lt;sup>3</sup> This parameter may need to be expanded to allow for proper capture of the LSB. After CS goes high, the DOUT line enters a high impedance state.

### **ABSOLUTE MAXIMUM RATINGS**

Table 3.

Parameter	Rating
Acceleration	
Any Axis, Unpowered, 0.5 ms	2000 <i>g</i>
Any Axis, Powered, 0.5 ms	2000 <i>g</i>
VCC to GND	-0.3 V to +6.0 V
Digital Input/Output Voltage to GND	−0.3 V to +5.3 V
Analog Inputs to GND	-0.3 V to +3.5 V
Operating Temperature Range <sup>1</sup>	-40°C to +105°C
Storage Temperature Range <sup>1</sup>	−65°C to +150°C

 $<sup>^1</sup>$  Extended exposure to temperatures outside the temperature range of  $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$  can adversely affect the accuracy of the factory calibration. For best accuracy, store the part within the temperature range of  $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ .

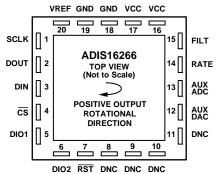
Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

#### **ESD CAUTION**



**ESD** (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

### PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

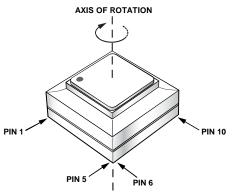


NOTES

1. DNC = DO NOT CONNECT.

2. THE PINS CANNOT BE SEEN FROM THE TOP.
THIS LOOK-THOUGH VIEW OF THEIR LOCATION
IS OFFERED FOR REFERENCE IN DEVELOPING
PCB PATTERNS.

Figure 4. Pin Configuration



NOTES

THAT PRODUCES A POSITIVE RESPONSE IN THE GYRO\_OUT REGISTER.

Figure 5. Axial Orientation

**Table 4. Pin Function Descriptions** 

Table 4. Fill	1 able 4. Pin Function Descriptions					
Pin No.	Mnemonic	Type <sup>1</sup>	Description			
1	SCLK	1	SPI Serial Clock.			
2	DOUT	0	SPI Data Output. DOUT clocks the output on the falling edge of SCLK.			
3	DIN	1	SPI Data Input. DIN clocks the input on the rising edge of SCLK.			
4	<u>CS</u>	1	SPI Chip Select. Active low.			
5, 6	DIO1, DIO2	I/O	Configurable Digital Input/Output.			
7	RST	1	Reset. Active low.			
8, 9, 10, 11	DNC		Do Not Connect.			
12	AUX DAC	0	Auxiliary DAC Output.			
13	AUX ADC	1	Auxiliary ADC Input.			
14	RATE	0	Rate Output. For bandwidth reduction only, the output is not specified.			
15	FILT	1	Filter Terminal.			
16, 17	VCC	S	5.0 V Power Supply.			
18, 19	GND	S	Ground.			
20	VREF	0	Precision Reference Output.			

 $<sup>^{1}</sup>$  I = input, I/O = input/output, O = output, and S = supply.

# TYPICAL PERFORMANCE CHARACTERISTICS

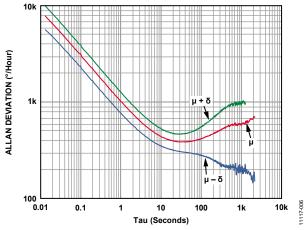


Figure 6. Allan Variance Plot

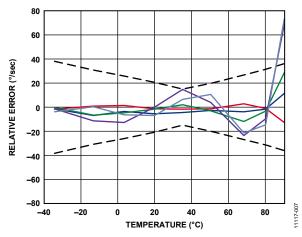


Figure 7. Bias vs. Temperature

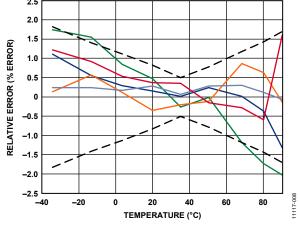


Figure 8. Sensitivity vs. Temperature

#### THEORY OF OPERATION

The ADIS16266 integrates a MEMS gyroscope with data sampling, signal processing, and calibration functions, along with a simple user interface. This sensing system collects data autonomously and makes it available to any processor system that supports a 4-wire serial peripheral interface (SPI).

#### **SENSING ELEMENT**

The sensing element operates on the principle of a resonator gyro. Two polysilicon sensing structures each contain a dither frame that is electrostatically driven to resonance, producing the necessary velocity element to generate a Coriolis force during angular rate. At two of the outer extremes of each frame, orthogonal to the dither motion, movable fingers are placed between fixed pickoff fingers to form a capacitive pickoff structure that senses Coriolis motion. The resulting signal is fed into a series of gain and demodulation stages that produce the electrical rate signal output. The differential structure minimizes the response to linear acceleration (gravity, vibration, and so on) and EMI.

#### **DATA SAMPLING AND PROCESSING**

The ADIS16266 runs autonomously, based on the configuration in the user control registers. The analog gyroscope signal feeds into an analog-to-digital converter (ADC) stage, which passes digitized data into the controller for data processing and register loading. Data processing in the embedded controller includes correction formulas, filtering, and checking for preset alarm conditions. The correction formulas are unique for each individual ADIS16266 and come from the factory characterization of each device over a temperature range of  $-40^{\circ}\text{C}$  to  $+70^{\circ}\text{C}$ .

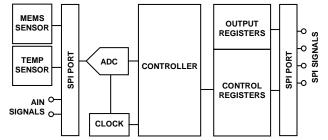


Figure 9. Simplified Sensor Signal Processing Diagram

#### **USER INTERFACE**

#### **SPI** Interface

Data collection and configuration commands both use the SPI, which consists of four wires. The chip select  $(\overline{CS})$  signal activates the SPI interface, and the serial clock (SCLK) signal synchronizes the serial data lines. The serial input data clocks into DIN on the SCLK rising edge, and the serial output data clocks out of DOUT on the SCLK falling edge. Many digital processor platforms support this interface with dedicated serial ports and simple instruction sets.

#### **User Registers**

The user registers provide addressing for all input/output operations on the SPI interface. Each 16-bit register has its own unique bit assignment and has two 7-bit addresses: one for its upper byte and one for its lower byte. Table 7 provides a memory map of the user registers, along with the function of each register.

#### BASIC OPERATION

The ADIS16266 is an autonomous system that requires no user initialization. As soon as it has a valid power supply, it initializes and starts sampling, processing, and loading sensor data into the output registers. After each sample cycle concludes, DIO1 pulses high. The SPI interface enables simple integration with many embedded processor platforms, as shown in Figure 10 (electrical connection) and Table 5 (processor pin names and functions).

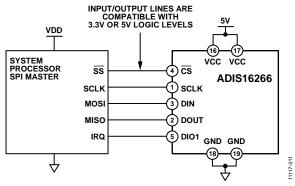


Figure 10. Electrical Connection Diagram

Table 5. Generic Master Processor Pin Names and Functions

Pin Name	Function
SS	Slave select
IRQ	Interrupt request
MOSI	Master output, slave input
MISO	Master input, slave output
SCLK	Serial clock

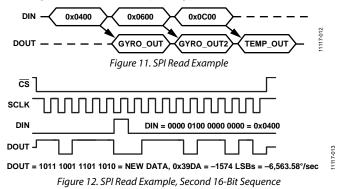
The SPI interface of the ADIS16266 supports full duplex serial communication (simultaneous transmit and receive) and uses the bit sequence shown in Figure 13. Table 6 provides a list of the most common settings that require attention to initialize a processor serial port for the SPI interface of the ADIS16266.

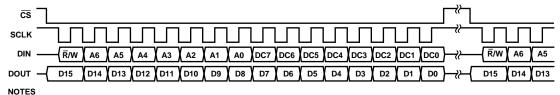
Table 6. Generic Master Processor SPI Settings

<b>Processor Setting</b>	Description
Master	ADIS16266 operates as a slave
SCLK Rate ≤ 2.5 MHz	Maximum serial clock rate
SPI Mode 3	CPOL = 1 (polarity), CPHA = 1 (phase)
MSB First Mode	Bit sequence
16-Bit Mode	Shift register/data length

#### **READING SENSOR DATA**

A single register read requires two 16-bit SPI cycles. The first cycle requests the contents of a register using the bit assignments in Figure 13. Then, the register contents follow on DOUT during the second sequence. Figure 11 includes three single register reads in succession. In this example, the process starts with Pin 3, DIN = 0x0400, to request the contents of the GYRO\_OUT register and follows with 0x0600 to request the contents of the GYRO\_OUT2 register and with 0x0C00 to request the contents of the TEMP\_OUT register. Full duplex operation enables processors to use the same 16-bit SPI cycle to read data from DOUT while requesting the next set of data on the DIN pin. Figure 12 provides an example of the four SPI signals when reading GYRO\_OUT in a repeating pattern.





- 1. DOUT BITS ARE PRODUCED ONLY WHEN THE PREVIOUS 16-BIT DIN SEQUENCE STARTS WITH  $\overline{R}/W=0$ .
- 2. WHEN CS IS HIGH, DOUT IS IN A THREE-STATE, HIGH IMPEDANCE MODE, WHICH ALLOWS MULTIFUNCTIONAL USE OF THE LINE

Figure 13. SPI Communication Bit Sequence

### **USER REGISTERS**

Table 7. User Register Memory Map

Name	R/W	Flash Backup	Address <sup>1</sup>	Default	Register Description	Bit Descriptions
FLASH_CNT	R	Yes	0x00	N/A <sup>2</sup>	Flash memory write count	See Table 27
SUPPLY_OUT	R	No	0x02	N/A <sup>2</sup>	Output, power supply	See Table 13
GYRO_OUT	R	No	0x04	N/A <sup>2</sup>	Output, gyroscope	See Table 8
GYRO_OUT2	R	No	0x06	N/A <sup>2</sup>	Output, gyroscope, bit growth from decimation	See Table 10
Reserved	$N/A^2$	N/A <sup>2</sup>	0x08	N/A <sup>2</sup>	Reserved	
AUX_ADC	R	No	0x0A	N/A <sup>2</sup>	Output, auxiliary ADC measurement	See Table 15
TEMP_OUT	R	No	0x0C	N/A <sup>2</sup>	Output, temperature (internal)	See Table 11
Reserved	$N/A^2$	N/A <sup>2</sup>	0x0F to 0x13	N/A <sup>2</sup>	Reserved	
GYRO_OFF	R/W	Yes	0x14	0x0000	Gyroscope bias correction	See Table 19
GYRO_SCALE	R/W	Yes	0x16	0x0800	Gyroscope scale correction	See Table 20
Reserved	$N/A^2$	N/A <sup>2</sup>	0x18 to 0x1F	N/A <sup>2</sup>	Reserved	
ALM_MAG1	R/W	Yes	0x20	0x0000	Alarm 1 trigger setting	See Table 30
ALM_MAG2	R/W	Yes	0x22	0x0000	Alarm 2 trigger setting	See Table 31
ALM_SMPL1	R/W	Yes	0x24	0x0000	Alarm 1 sample period	See Table 32
ALM_SMPL2	R/W	Yes	0x26	0x0000	Alarm 2 sample period	See Table 33
ALM_CTRL	R/W	Yes	0x28	0x0000	0x0000 Alarm configuration	
Reserved	$N/A^2$	N/A <sup>2</sup>	0x2B to 0x2F	N/A <sup>2</sup>	'A <sup>2</sup> Reserved	
AUX_DAC	R/W	No	0x30	0x0000	0 Control, DAC output voltage setting See Tabl	
GPIO_CTRL	R/W	No	0x32	0x0000	Control, digital I/O line	See Table 23
MSC_CTRL	R/W	Yes	0x34	0x0006	Control, data ready, self-test settings	See Table 24
SMPL_PRD	R/W	Yes	0x36	0x0000	Control, internal sample rate	See Table 17
SENS_AVG	R/W	Yes	0x38	0x0401	Control, dynamic range, filtering	See Table 18
SLP_CNT	W	Yes	0x3A	N/A <sup>2</sup>	Control, sleep mode initiation	See Table 22
DIAG_STAT	R	No	0x3C	N/A <sup>2</sup>	Diagnostic, error flags	See Table 29
GLOB_CMD	W	No	0x3E	$N/A^2$	N/A <sup>2</sup> Control, global commands	
			0x40 to 0x51	I N/A <sup>2</sup> Reserved		
LOT_ID1	R	Yes	0x52	N/A	Lot Identification Code 1	See Table 37
LOT_ID2	R	Yes	0x54	N/A <sup>2</sup>	Lot Identification Code 2	See Table 37
PROD_ID	R	Yes	0x56	0x3F8A	Product identifier; 16,266	See Table 37
SERIAL_NUM	R	Yes	0x58	N/A <sup>2</sup>	Serial number	See Table 37

<sup>&</sup>lt;sup>1</sup> Each register contains two bytes. The address column in this table only offers the address of the lower byte. Add 1 to it to calculate the address of the upper byte. <sup>2</sup> N/A means not applicable.

#### **OUTPUT DATA REGISTERS**

Figure 14 displays the generic pattern for the format of the output registers. The ND bit is equal to 1 when the register contains unread data. The EA bit is high when any error/alarm flag in the DIAG\_STAT register is equal to 1.



Figure 14. Output Register Bit Assignments

#### Rotation Rate (Gyroscope)

GYRO\_OUT (see Table 8) is the primary register for gyroscope output data and uses 14-bit twos complement format for its data. Table 9 provides several examples for converting digital data into °/sec.

Table 8. GYRO\_OUT Bits (Base Address = 0x04)

Bits	Description
15	New (unread) data indicator; bit = 1 indicates new, unread data in this register
14	Error/alarm; bit = 1 when DIAG_STAT ≠ 0x0000
[13:0]	Gyroscope data; twos complement, 4.17°/sec per LSB, 0°/sec = 0x0000

Table 9. GYRO\_OUT, Twos Complement Format

<b>Rotation Rate</b>	Decimal	Hex	Binary
+14000°/sec	+3357	0x0D1D	xx00 1101 0001 1101
+8.34°/sec	+2	0x0002	xx00 0000 0000 0010
+4.17°/sec	+1	0x0001	xx00 0000 0000 0001
0°/sec	0	0x0000	xx00 0000 0000 0000
–4.17°/sec	-1	0x3FFF	xx11 1111 1111 1111
-8.34°/sec	-2	0x3FFE	xx11 1111 1111 1110
-14000°/sec	-3357	0x32E3	xx11 0010 1110 0011

The GYRO\_OUT2 register (see Table 10) captures the bit growth associated with the decimation filter (see Figure 19) using an MSB justified format. The bit growth starts with the MSB (GYRO\_OUT2[15]), is equal to the decimation rate setting in SMPL\_PRD[3:0] (see Table 17), and grows in the LSB direction as the decimation rate increases.

Table 10. GYRO\_OUT2 Bits (Base Address = 0x06)

RITS	Description		
[15:0]	Rotation rate data; resolution enhancement bits		
	<b>⊢</b> D−	→ D = SMPL_PRD[3:0]	
	GYROSCOPE DATA	NOT USED	
13 _	GYRO_OUT015	GYRO_OUT2 0	
BIT V	$VEIGHT = \frac{4.17}{2^{D}} \frac{^{\circ}/sec}{LSB} LSB = G$	/RO_OUT2[16 – D] \$\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	

Figure 15. Gyroscope Output Format

#### **Internal Temperature**

The TEMP\_OUT register (see Table 11) provides access to a sensor that monitors internal temperature, which influences the calibration correction formulas for the gyroscope data. Note that this difference between internal and ambient temperatures is dependent on many factors, which can introduce variation that can approach  $\pm 10^{\circ}$ C. This temperature measurement is useful for tracking relative changes in temperature.

Table 11. TEMP\_OUT Bits (Base Address = 0x0C)

Bits	Description
15	New (unread) data indicator; bit = 1 indicates new, unread data in this register
14	Error/alarm; bit = 1 when DIAG_STAT ≠ 0x0000
[13:12]	Not used
[11:0]	Temperature data; twos complement, 0.1447°C per LSB, $0^{\circ}$ C = 0x000

Table 12. Temperature, Twos Complement Format

Temperature	Decimal	Hex	Binary Output
+105°C	+544 LSB	0x220	xxxx 0010 0010 0000
+25.2894°C	+2 LSB	0x002	xxxx 0000 0000 0010
+25.1447°C	+1 LSB	0x001	xxxx 0000 0000 0001
+25°C	0 LSB	0x000	xxxx 0000 0000 0000
+24.8553°C	−1 LSB	0xFFF	xxxx 1111 1111 1111
+24.7106°C	−2 LSB	0xFFE	xxxx 1111 1111 1110
−40°C	-449 LSB	0xE3F	xxxx 1110 0011 1111

#### **Power Supply Voltage**

The SUPPLY\_OUT (see Table 13) register provides a digital representation of the power supply voltage, across VDD and GND.

Table 13. SUPPLY\_OUT Bits (Base Address = 0x02)

Bits	Description
15	New (unread) data indicator; bit = 1 indicates new, unread data in this register
14	Error/alarm; bit = 1 when DIAG_STAT $\neq$ 0x0000
[13:12]	Not used
[11:0]	Power supply (VDD) data, binary (0 V = $0x000$ ) 1.83 mV/LSB

**Table 14. Power Supply Voltage Data Format Examples** 

Supply Voltage (V)	Decimal	Hex	Binary Output
5.25	2867 LSB	0xB33	xxxx 1011 0011 0011
5.0 + 0.00183	2731 LSB	0xAAB	xxxx 1010 1010 1011
5.0	2730 LSB	0xAAA	xxxx 1010 1010 1010
5.0 - 0.00183	2729 LSB	0xAA9	xxxx 1010 1010 1001
4.75	2594 LSB	0xA22	xxxx 1010 0010 0010

#### Auxiliary Input Voltage (AUX\_ADC)

The AUX\_ADC (see Table 15) register provides a digital representation of the voltage on the AUX\_ADC pin.

Table 15. AUX\_ADC Bits (Base Address = 0x0A)

Bits	Description
15	New (unread) data indicator; bit = 1 indicates new, unread data in this register
14	Error/alarm; bit = 1 when DIAG_STAT ≠ 0x0000
[13:12]	Not used
[11:0]	Auxiliary input voltage, binary (0 V = 0x000) 0.6105 mV/LSB

Table 16. AUX\_ADC Voltage Data Format Examples

Input (mV)	Decimal	Hex	Binary Output
2500	4095 LSB	0xFFF	xxxx 1111 1111 1111
1200	1966 LSB	0x7AE	xxxx 0111 1010 1110
0.6105	1 LSB	0x001	xxxx 0000 0000 0001
0	0 LSB	0x000	xxxx 0000 0000 0000

#### **DEVICE CONFIGURATION**

The control registers listed in Table 7 provide a variety of user configuration options. The SPI provides access to these registers, one byte at a time, using the bit assignments shown in Figure 13. Each register has 16 bits, wherein Bits[7:0] represent the lower address, and Bits[15:8] represent the upper address. Figure 16 provides an example of writing 0x03 to Address 0x32 (GPIO\_CTRL[7:0], see Table 23).

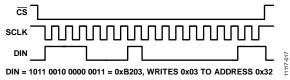


Figure 16. SPI Sequence for Setting the Decimate Rate to 8 (DIN = 0xB203)

#### **Dual Memory Structure**

Writing configuration data to a control register updates its SRAM contents, which are volatile. After optimizing each relevant control register setting in a system, set GLOB\_CMD[3] = 1 (DIN = 0xBE08) to back up these settings in the nonvolatile flash memory. The flash backup process requires a valid power supply level for the entire 40 ms process time. Table 7 provides a register memory map that includes a column of flash backup information. A yes in this column indicates that a register has a mirror location in flash and, when backed up properly, automatically restores itself during startup or after a reset. Figure 17 provides a diagram of the dual memory structure that is used to manage operation and store critical user settings.

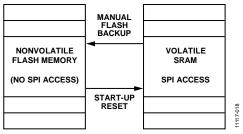


Figure 17. SRAM and Flash Memory Diagram

#### DIGITAL SIGNAL PROCESSING

Figure 19 provides a signal processing diagram that describes all of the user-configurable options, which influence sample rate and the frequency response. Using the factory default settings for the SMPL\_PRD and SENS\_AVG registers, the effective sensor bandwidth is 360 Hz.

#### **DECIMATION FILTER (UPDATE RATE)**

The internal sampling system produces new data in the output data registers at a rate of 2429 SPS. The SMPL\_PRD register (see Table 17) provides the functional control for the decimation filter stage, which provides a user control input for reducing the update rate in the output registers. The decimation filter reduces the update rate, using an averaging filter with a decimated output. These bits provide a binomial control that divides the data rate by a factor of 2 every time this number increases by 1. For example, set  $SMPL_PRD[3:0] = 00100 \ (DIN = 0xB604) \ to set the decimation factor to 16. This reduces the update rate to 151.8 SPS and the bandwidth (<math>-3\ dB$ ) to  $\sim$ 75 Hz.

Table 17. SMPL\_PRD Bits (Base Address = 0x36)

Bits	Description (Default = 0x0000)
[15:4]	Not used
[3:0]	Decimation setting (D), see Figure 19

#### **FREQUENCY RESPONSE**

#### **Analog Filter**

Prior to the analog-to-digital conversion stage, the ADIS16266 has a two-pole analog filter, with both poles located at  $\sim$ 1.6 kHz. The RATE and FILT pins provide access to the amplifier feedback path on one of these filters. This provides an opportunity to reduce the cut-off frequency associated with this filter pole, according to the following relationship.

$$f_C = \frac{1}{2\pi \times 180000 \times (C + 560 \text{ pF})}$$

For example, adding a 1000 pF capacitor reduces this pole to  ${\sim}567~\mathrm{Hz}.$ 

#### **Digital Filtering**

A programmable low-pass filter provides additional noise reduction on the inertial sensor outputs. This filter contains two cascaded averaging filters that provide a Bartlett window, FIR filter

response (see Figure 19). For example, set SENS\_AVG[2:0] = 100 (DIN = 0 xB804) to set each stage to 16 taps. When used with the default sample rate of 2429 SPS (no decimation), this reduces the band-width of the digital filter to approximately 49 Hz. The minimum setting for this filter is two taps per stage (SENS\_AVG[2:0]  $\geq 001$ ).

Table 18. SENS\_AVG Bits (Base Address = 0x38)

Bits	Description (Default = 0x0401)
[15:11]	Not used.
[10:8]	Measurement range (sensitivity) selection.
	$100 = \pm 14,000^{\circ}/\text{sec}$ , filter taps $\geq 2$ (Bits[2:0] $\geq 0x01$ ).
	$010 = \pm 7000^{\circ}/\text{sec}$ , filter taps $\ge 4$ (Bits[2:0] $\ge 0x02$ ). $001 = \pm 3500^{\circ}/\text{sec}$ , filter taps $\ge 16$ (Bits[2:0] $\ge 0x04$ ).
	$001 = \pm 3500^{\circ}/\text{sec}$ , filter taps $\geq 16$ (Bits[2:0] $\geq 0x04$ ).
[7:3]	Not used.
[2:0]	Number of taps in each stage; value of m in $N = 2^m$ .

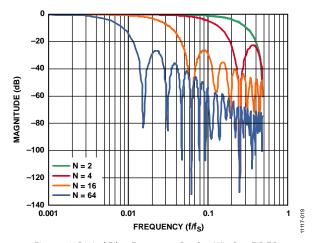


Figure 18. Digital Filter Frequency, Bartlett Window FIR Filter (Phase = N Samples)

#### **DYNAMIC RANGE**

The SENS\_AVG[10:8] bits provide three dynamic range settings for this gyroscope. The lower dynamic range settings ( $\pm 3500^{\circ}$ /sec and  $\pm 7000^{\circ}$ /sec) limit the minimum filter tap sizes to maintain resolution. For example, set SENS\_AVG[10:8] = 010 (DIN = 0xB902) for a measurement range of  $\pm 7000^{\circ}$ /sec. Because this setting can influence the filter settings, program SENS\_AVG[10:8] and then SENS\_AVG[2:0] if more filtering is required.

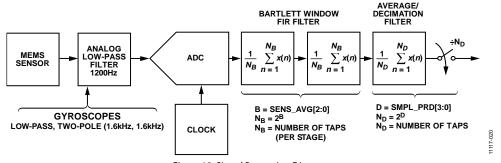


Figure 19. Signal Processing Diagram

### **CALIBRATION**

The GYRO\_OFF and GYRO\_SCALE registers provide user controls for making in-system adjustments to offset and the scale factor.

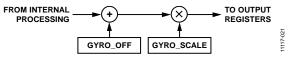


Figure 20. User Calibration Registers

Table 19. GYRO\_OFF Bits (Base Address = 0x14)

Bits	Description (Default = 0x0000)
[15:12]	Not used.
[11:0]	Offset adjustment factor, twos complement format, 1.04°/sec per LSB. Examples:
	i i
	0x000: add 0°/sec to gyroscope data.
	0x001: add 1.04°/sec to gyroscope data.
	0x0AA: add 176.8°/sec to gyroscope data.
	0xF0F: subtract 250.64°/sec from gyroscope data.
	0xFFF: subtract 1.04°/sec from gyroscope data.

Table 20. GYRO\_SCALE Bits (Base Address = 0x16)

Bits	Description (Default = 0x0800)
[15:12]	Not used.
[11:0]	Scale adjustment factor, offset binary format, 0.00048828/LSB. Examples:
	0x000: multiply output by 0.
	0x7F0: multiply gyroscope data by 0.99218.
	0x800: multiply output by 1.
	0x8A0: multiply output by 1.078122.
	0xFFF: multiply output by 1.9995.

#### SYSTEM TOOLS

#### **Global Commands**

The GLOB\_CMD register provides trigger bits for several functions. Setting the assigned bit to 1 starts each operation, which returns the bit to 0 after completion. For example, set GLOB\_CMD[7] = 1 (DIN = 0xBE80) to execute a software reset, which stops the sensor operation and runs the device through its start-up sequence. This sequence includes loading the control registers with the contents of their respective flash memory locations prior to producing new data.

Table 21. GLOB\_CMD Bits (Base Address = 0x3E)

	_ ,
Bits	Description
[15:8]	Not used.
7	Software reset command.
6:4	Not used.
3	Flash update command.
2	Auxiliary DAC data latch.
1	Factory calibration restore command.
0	Autonull command.

#### **Power Management**

Use SLP\_CNT[7:0] to put the device into sleep mode for a specified period. For example,  $SLP_CNT[7:0] = 0x64$  (DIN = 0xBA64) puts the ADIS16266 to sleep for 50 seconds.

Table 22.  $SLP\_CNT$  Bits (Base Address = 0x3A)

Bits	Description
[15:8]	Not used.
[7:0]	Programmable sleep time bits, 0.5 sec/LSB.

#### General-Purpose I/O

DIO1 and DIO2 are configurable, general-purpose I/O lines that serve multiple purposes according to the following control register priority: MSC\_CTRL, ALM\_CTRL, and GPIO\_CTRL. For example, set GPIO\_CTRL = 0x0202 (DIN = 0xB302, and then 0xB202) to configure DIO1 as an input and DIO2 as an output that is set high.

Table 23. GPIO\_CTRL Bits (Base Address = 0x32)

Bits	Description (Default = 0x0000)
[15:10]	Not used.
9	General-Purpose I/O Line 2 (DIO2) data level.
8	General-Purpose I/O Line 1 (DIO1) data level.
[7:2]	Not used.
1	General-Purpose I/O Line 2 (DIO2) direction control.
	1 = output, 0 = input.
0	General-Purpose I/O Line 1 (DIO1) direction control.
	1 = output, 0 = input.

#### Data Ready I/O Indicator

The MSC\_CTRL[2:0] bits configure one of the digital I/O lines as a data ready signal for driving an interrupt. For example, set MSC\_CTRL[2:0] = 100 (DIN = 0xB404) to configure DIO1 as a negative-pulse data ready signal. The pulse width is between 100 µs and 200 µs over all conditions.

Table 24. MSC\_CTRL Bits (Base Address = 0x34)

Bits	Description (Default = 0x0006)
[15:12]	Not used.
11	Memory test (cleared upon completion).
	1 = enabled, 0 = disabled.
10	Internal self-test enable (cleared upon completion).
	1 = enabled, 0 = disabled.
9	Manual self-test, negative stimulus.
	1 = enabled, 0 = disabled.
8	Manual self-test, positive stimulus.
	1 = enabled, 0 = disabled.
7:3	Not used.
2	Data ready enable.
	1 = enabled, 0 = disabled.
1	Data ready polarity.
	1 = active high, 0 = active low.
0	Data ready line select.
	1 = DIO2, 0 = DIO1.

#### **Auxiliary DAC**

The 12-bit AUX\_DAC line can drive its output to within 5 mV of the ground reference when it is not sinking current. As the output approaches 0 V, the linearity begins to degrade (~100 LSB starting point). As the sink current increases, the nonlinear range increases. The DAC latch command (GLOB\_CMD[2]) moves the values of the AUX\_DAC register into the internal DAC control register, enabling both bytes to take effect at the same time.

Table 25. AUX\_DAC Bits (Base Address = 0x30)

Bits	Description (Default = 0x0000)
[15:12]	Not used.
[11:0]	Data bits, scale factor = 0.6105 mV/code.
	Offset binary format, $0 V = 0$ codes.

Table 26. Setting  $AUX_DAC = 2V$ 

DIN	Description
0xB0CC	$AUX\_DAC[7:0] = 0xCC (204 LSB).$
0xB10C	$AUX_DAC[15:8] = 0x0C (3072 LSB).$
0xBE04	$GLOB\_CMD[2] = 1.$
	Latch AUX_DAC values into the internal DAC control register which causes the output voltage to settle at a value of 2 V.

#### **Memory Management**

The FLASH\_CNT register (see Table 27) tracks the number of write cycles for the flash memory to help manage the total cycles against the endurance ratings in Table 1.

Table 27. FLASH\_CNT Bits (Base Address = 0x00)

Bits	Description
[15:0]	Flash update counter

#### **DIAGNOSTICS**

#### Self-Test

The self-test function allows the user to verify the mechanical integrity of each MEMS sensor. It applies an electrostatic force to each sensor element, which results in mechanical displacement that simulates a response to actual motion. Table 1 lists the expected response for the sensor, which provides pass/fail criteria.

Set MSC\_CTRL[10] = 1 (DIN = 0xB504) to run the internal self-test routine, which exercises the inertial sensor, measures the response, makes a pass/fail decision, reports the decision to the error flags in the DIAG\_STAT register, and then restores normal operation. MSC\_CTRL[10] resets itself to 0 after completing the routine. The MSC\_CTRL[9:8] bits provide manual control of the self-test function for investigation of potential failures. Table 28 outlines an example test flow for using this option to verify the gyroscope function.

Table 28. Manual Self-Test Example Sequence

DIN	Description
0xB601	SMPL_PRD[7:0] = 0x01, sample rate = 2429 SPS.
0xB904	SENS_AVG[15:8] = 0x04, range = ±14000°/sec.
0xB802	SENS_AVG[7:0] = $0x02$ , four-tap averaging filter.
	Delay = 50 ms.
0x0400	Read GYRO_OUT.
0xB502	$MSC\_CTRL[9:8] = 10$ , gyroscope negative self-test.
	Delay = 50 ms.
0x0400	Read GYRO_OUT.
	Determines whether the bias in the gyroscope output changed according to the self-test response specified in Table 1.
0xB501	$MSC\_CTRL[9:8] = 01$ , gyroscope positive self-test.
	Delay = 50 ms.
0x0400	Read GYRO_OUT.
	Determines whether the bias in the gyroscope output changed according to the self-test response specified in Table 1.
0xB500	$MSC\_CTRL[15:8] = 0x00.$

Zero motion provides results that are more reliable. The settings in Table 28 are flexible and allow for optimization around speed and noise influence. For example, using fewer filtering taps decreases delay times but increases the potential for noise influence.

#### **Memory Test**

Setting MSC\_CTRL[11] = 1 (DIN = 0xB508) performs a checksum comparison between the flash memory and SRAM to help verify memory integrity. The pass/fail result is loaded into the DIAG\_STAT[6] register.

#### Status

The error flags provide indicator functions for common system level issues. All of the flags are cleared (set to 0) after each DIAG\_STAT register read cycle. If an error condition remains, the error flag returns to 1 during the next sample cycle. DIAG\_STAT[1:0] does not require a read of this register to return to 0. When the power supply voltage goes back into range, these two flags clear automatically.

Table 29. DIAG STAT Bits (Base Address = 0x3C)

Table 29. DIAG_STAT bits (base Address = 0x3C)	
Bits	Description
[15:10]	Not used.
9	Alarm 2 status (1 = active, $0 = inactive$ ).
8	Alarm 1 status (1 = active, 0 = inactive).
7	Not used.
6	Flash test, checksum flag $(1 = fail, 0 = pass)$ .
5	Self-test diagnostic error flag (1 = fail, 0 = pass).
4	Sensor overrange (1 = fail, 0 = pass).
3	SPI communication failure (1 = fail, 0 = pass).
2	Flash update failure $(1 = fail, 0 = pass)$ .
1	Power supply > 5.25 V.
	$1 = power supply > 5.25 V$ , $0 = power supply \le 5.25 V$ .
0	Power supply < 4.75 V.
	$1 = \text{power supply} < 4.75 \text{ V}, 0 = \text{power supply} \ge 4.75 \text{ V}.$

### **ALARMS**

#### **Alarm Registers**

The alarm function provides monitoring for two independent conditions. The ALM\_CTRL register provides control inputs for data source selection, data filtering (prior to comparison), static comparison, dynamic rate-of-change comparison, and output indicator configurations. The ALM\_MAGx registers establish the trigger threshold and polarity configurations. Table 35 gives an example of how to configure a static alarm. The ALM\_SMPLx registers provide the numbers of samples to use in the dynamic rate-of-change configuration. The period equals the number in the ALM\_SMPLx register multiplied by the sample period time. See Table 36 for an example of how to configure the sensor for this type of function.

Table 30. ALM\_MAG1 Bits (Base Address = 0x20)

Bits	Description (Default = 0x0000)
15	Comparison polarity (1 = greater than, $0 = less than$ ).
14	Not used.
[13:0]	Data bits that match the format of the trigger source selection.

Table 31. ALM\_MAG2 Bits (Base Address = 0x22)

Bits	Description (Default = 0x0000)
15	Comparison polarity (1 = greater than, $0 = less than$ ).
14	Not used.
[13:0]	Data bits that match the format of the trigger source selection.

Table 32. ALM\_SMPL1 Bits (Base Address = 0x24)

Bits	Description (Default = 0x0000)
[15:8]	Not used.
[7:0]	Data bits: number of samples (both $0x00$ and $0x01 = 1$ ).

Table 33. ALM\_SMPL2 Bits (Base Address = 0x26)

Bits	Description (Default = 0x0000)
[15:8]	Not used.
[7:0]	Data bits: number of samples (both $0x00$ and $0x01 = 1$ ).

Table 34. ALM CTRL Bits (Base Address = 0x28)

Tubic 3	ALM_CIRL Dits (Dasc Address = 0x20)
Bits	Description (Default = 0x0000)
15	Dynamic rate-of-change enable for Alarm 2 (1 = rate
	of change, 0 = static level).
[14:12]	Alarm 2 source selection.
	000 = disable.
	001 = power supply output.
	010 = gyroscope output.
	011 = not used.
	100 = not used.
	101 = auxiliary ADC input.
	110 = temperature output.
	111 = not used.
11	Rate-of-change enable for Alarm 1 (1 = dynamic rate of change, 0 = static level).
[10:8]	Alarm 1 source selection (same as for Alarm 2).
[7:5]	Not used.
4	Comparison data filter setting (1 = filtered data, 0 = unfiltered data).
3	Not used.
2	Alarm output enable (1 = enabled, $0 = disabled$ ).
1	Alarm output polarity (1 = active high, $0 =$ active low).
0	Alarm output line select (1 = DIO2, 0 = DIO1).

**Table 35. Alarm Configuration Example 1** 

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DIN	Description			
0xA922,	ALM_CTRL = 0x2217.			
0xA817	Alarm 1 input = GYRO_OUT.			
	Alarm 2 input = GYRO_OUT.			
	Static level comparison, filtered data.			
	DIO2 output indicator, positive polarity.			
0xA183,	$ALM\_MAG1 = 0x83E8.$			
0xA0E8	Alarm 1 is true if GYRO_OUT > +4170°/sec.			
0xA338,	ALM_MAG2 = 0x3830.			
0xA230	Alarm 2 is true if GYRO_OUT < -8340°/sec.			

**Table 36. Alarm Configuration Example 2** 

Tuble 30. Hurm Configuration Example 2				
DIN	Description			
0xA9AA,	ALM_CTRL = 0xAA04.			
0xA804	Alarm 1 input = GYRO_OUT.			
	Alarm 2 input = GYRO_OUT.			
	Dynamic rate-of-change comparison, unfiltered data.			
	DIO1 output indicator, negative polarity.			
0xB600	SMPL_PRD = 0x0000. Sample rate = 2429 SPS.			
0xA4FF	$ALM\_SMPL1[7:0] = 0x00FF.$			
	Alarm 1 dynamic rate-of-change period = 105 ms.			
0xA6FF	$ALM\_SMPL2[7:0] = 0x00FF.$			
	Alarm 2 dynamic rate-of-change period = 105 ms.			
0xA181,	ALM_MAG1 = 0x8100.			
0xA000	Alarm 1 is true if GYRO_OUT changes more than			
	1067.5°/sec over a period of 105 ms.			
0xA300,	$ALM\_MAG2 = 0x000A.$			
0xA20A	Alarm 2 is true if GYRO_OUT changes less than			
	41.7°/sec over a period of 105 ms.			

#### **PRODUCT IDENTIFICATION**

Table 37 provides a summary of the registers that identify the product: PROD\_ID, which identifies the product type; LOT\_ID1 and LOT\_ID2, the 32-bit lot identification code; and SERIAL\_NUM, which displays the 16-bit serial number. All four registers are two bytes in length.

**Table 37. Identification Registers** 

Register Name	Address	Description
LOT_ID1	0x52	Lot Identification Code 1
LOT_ID2	0x54	Lot Identification Code 2
PROD_ID	0x56	Product identification = 0x3F8A (0x3F8A = 16,266 decimal)
SERIAL_NUM	0x58	Serial number

# APPLICATIONS INFORMATION ASSEMBLY

When developing a process flow for installing ADIS16266 devices on printed circuit boards (PCBs), see the IPC/JEDEC J-STD-020C standard document for reflow temperature profile and processing information. The ADIS16266 can use the Sn-Pb eutectic process or the Pb-free eutectic process from this standard. See IPC/JEDEC J-STD-033 for moisture sensitivity level (MSL) handling requirements. The MSL rating for these devices is marked on the antistatic bags, which protect these devices from electrostatic discharge (ESD) during shipping and handling.

Prior to assembly, review the process flow for information about introducing shock levels that exceed the absolute maximum ratings for the ADIS16266. PCB separation and ultrasonic cleaning processes can introduce high levels of shock and damage the MEMS element. Bowing or flexing the PCB after solder reflow can also place large peeling stress on the pad structure and can damage the device. If this is unavoidable, consider using an underfill material to help distribute these forces across the bottom of the package. Figure 21 provides a PCB pad design example for this package style.

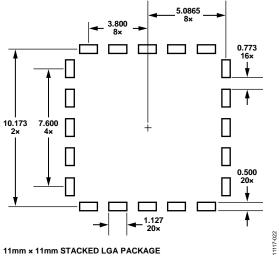


Figure 21. Recommended Pad Layout (Units in Millimeters)

#### **BIAS OPTIMIZATION**

Use the following steps to fine tune the bias to an accuracy that approaches the in-run bias stability,  $0.129^{\circ}/\text{sec}$  (1  $\sigma$ ):

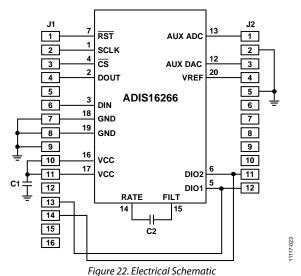
- 1. Apply 5 V and allow enough time to start up.
- 2. Set SENS\_AVG[10:8] = 001 (DIN = 0xB901).
- 3. Collect GYRO\_OUT data for 30 seconds at a sample rate of 2429 SPS.
- 4. Average data record.
- 5. Round to the nearest integer.
- 6. Multiply by -1.
- 7. Write the resulting number (from Step 6) to GYRO\_OFF.
- 8. Set  $GLOB\_CMD[3] = 1$  (DIN = 0xBE08).
- 9. Wait for >50 ms and resume operation.

Alternatively, setting GLOB\_CMD[0] = 1 (DIN = 0xBE01) provides a single sample, bias correction. The Allan variance curve (see Figure 6) provides a trade-off relationship between accuracy and averaging time. For example, an average time of 1 second produces an accuracy of  $\sim 0.358^{\circ}/\text{sec}$  (1  $\sigma$ ).

#### **INTERFACE PCB**

The ADIS16266/PCBZ includes one ADIS16266BCCZ IC on a 1.2 inch  $\times$  1.3 inch PCB. The interface PCB simplifies the IC connection of these devices to an existing processor system. The four mounting holes accommodate either M2 (2 mm) or 2-56 machine screws. These boards are made of IS410 material and are 0.063 inches thick. The second level assembly uses a SAC305-compatible solder composition, which has a presolder reflow thickness of approximately 0.005 inches.

The pad pattern on these PCBs matches that shown in Figure 23. J1 and J2 are dual-row, 2 mm (pitch) connectors that work with a number of ribbon cable systems, including the TCSD-08-D-xx.00-01 series from Samtec. The schematic and connector pin assignments for the ADIS16266/PCBZ are shown in Figure 22.



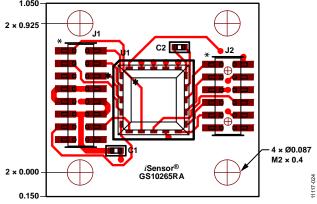


Figure 23. PCB Assembly View and Dimensions

### **OUTLINE DIMENSIONS**

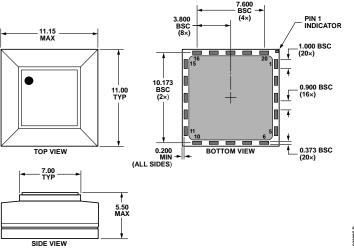


Figure 24. 20-Terminal Stacked Land Grid Array [LGA] (CC-20-1) Dimensions shown in millimeters

#### **ORDERING GUIDE**

Model <sup>1</sup>	Temperature Range	Package Description	Package Option
ADIS16266BCCZ	−40°C to +105°C	20-Terminal Stacked Land Grid Array [LGA]	CC-20-1
ADIS16266/PCBZ		Evaluation Board	

 $<sup>^{1}</sup>$  Z = RoHS Compliant Part.

# **NOTES**

**NOTES** 

# **Mouser Electronics**

**Authorized Distributor** 

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Analog Devices Inc.:

ADIS16266/PCBZ ADIS16266BCCZ